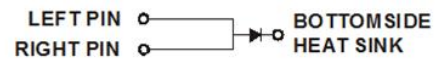
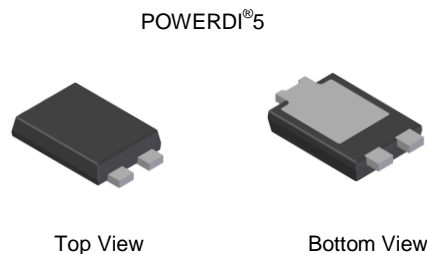


Features

- Designed as Bypass Diodes for Solar Panels
- Selectively Rated for +200°C Maximum Junction Temperature for High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- Low Forward Voltage Drop
- Excellent High Temperature Stability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: POWERDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 ⁽⁶³⁾
- Weight: 0.093 grams (Approximate)



Note: Pins Left & Right must be electrically connected at the printed circuit board.

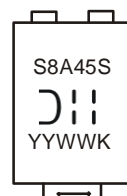
Ordering Information (Note 4)


Part Number	Case	Packaging
SBR8A45SP5-13	POWERDI [®] 5	5,000/Tape & Reel

- Notes:
- EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 - See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

POWERDI[®]5



S8A45S = Product Type Marking Code
 = Manufacturers' Code Marking
 K = Factory Designator
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 15 for 2015)
 WW = Week Code (01 ~ 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	45	V
Average Rectified Output Current	I _O	8	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	A

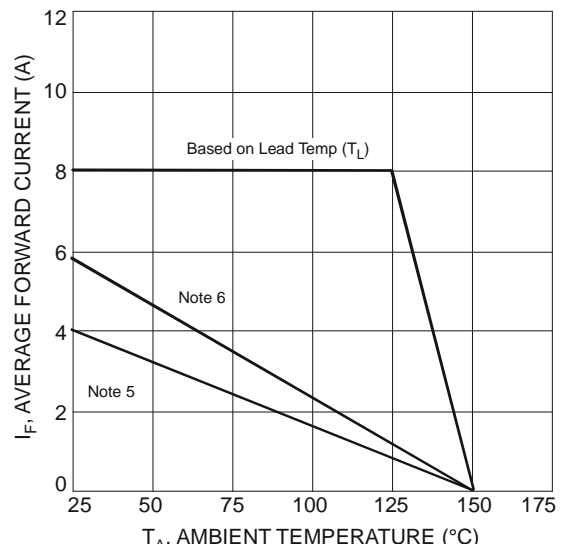
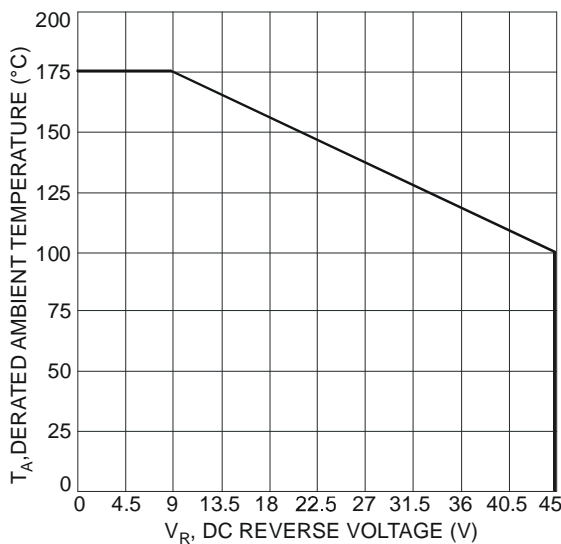
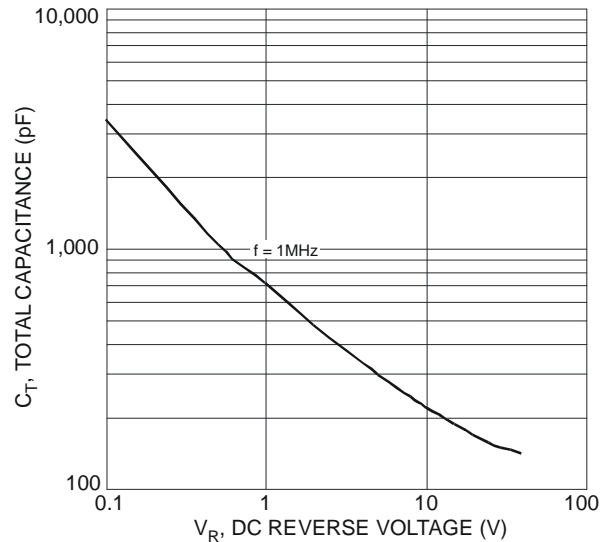
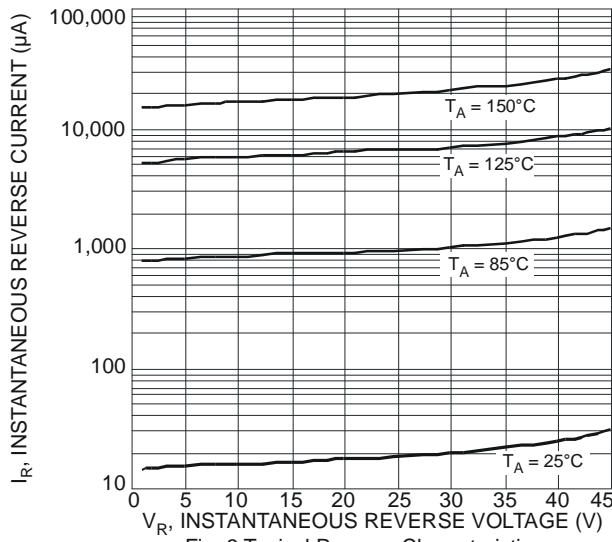
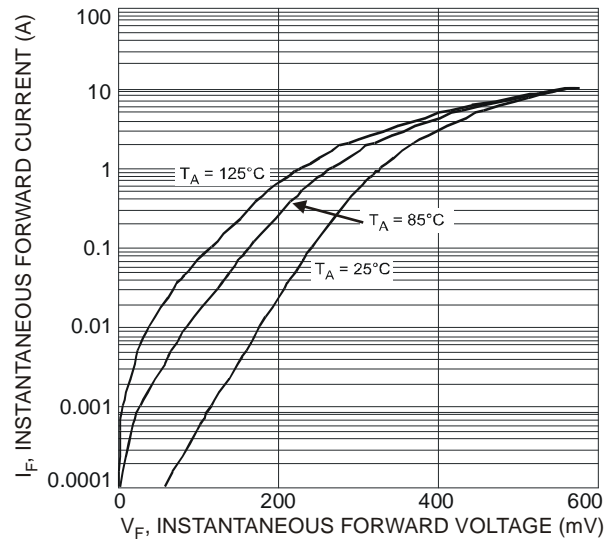
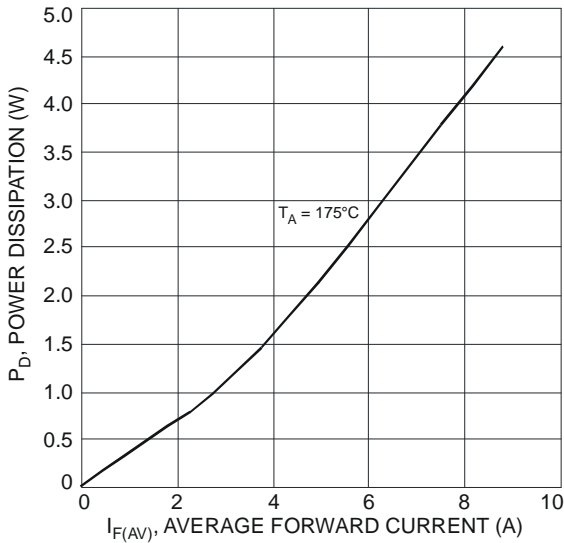
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Lead	R _{θJL}	3	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	8	°C/W
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	102	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	60	°C/W
Operating Temperature Range	V _R ≤ 80% V _{RRM}	-65 to +150	°C
	V _R ≤ 50% V _{RRM}	≤180	
	DC Forward Mode	≤200	
Storage Temperature Range	T _{STG}	-65 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

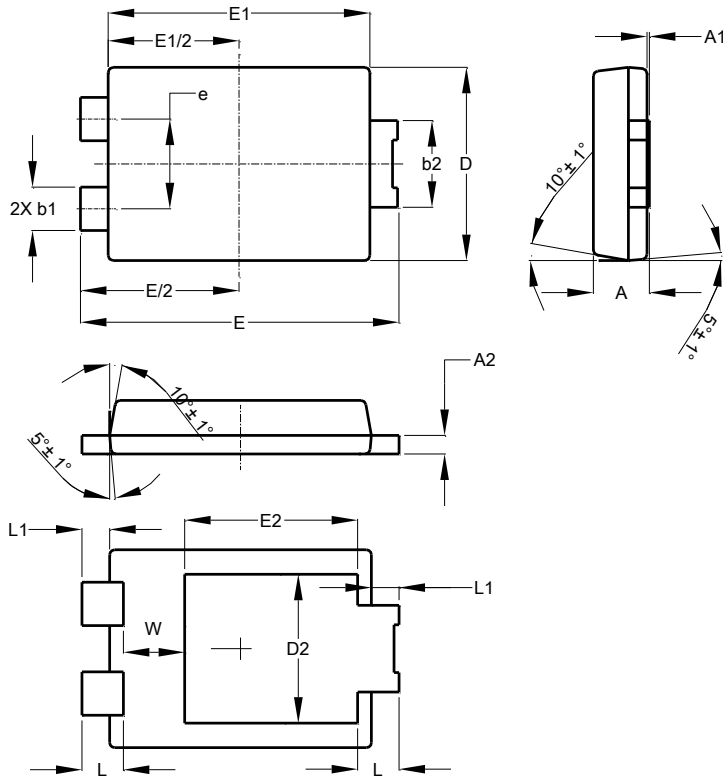
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	-	- 0.52	0.60 0.57	V	I _F = 8A, T _J = +25°C I _F = 8A, T _J = +125°C
Leakage Current (Note 7)	I _R	-	0.03 10	0.30 75	mA	V _R = 45V, T _J = +25°C V _R = 45V, T _J = +125°C

Notes: 5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
6. Polyimide PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
7. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

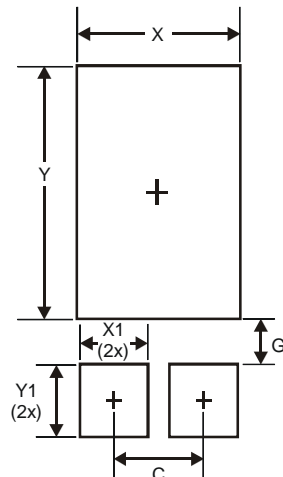
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



POWERDI [®] 5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	-	-	3.054
E	6.40	6.60	6.504
e	-	-	1.84
E1	5.30	5.45	5.37
E2	-	-	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400

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